

18V ULTRA LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Product Summary

V _{BR} MIN	IPP MAX	Ст түр	
19V	1A	0.3pF	

Features

- Low-Profile Package (0.53mm Max) and Ultra-Small PCB
 Footprint Area (1.08mm * 0.68mm Max) Suitable for Compact
 Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±15kV, Contact ±10kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DESD18VF1BLQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description And Applications

This new generation TVS is designed to protect sensitive electronics from damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in automotive applications such as:

- USB modules
- HDMI ports
- LVDS

Mechanical Data

- Package: X1-DFN1006-2
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Lead frame. Solderable per MIL-STD-202, Method 208 (24)
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Bottom View



Device Schematic

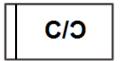
Ordering Information (Note 4)

Orderable Part Number	Package	Marking	Reel Size	Tape Width	Pac	king
Orderable Fart Number	Fackage	IVIAI KIIIG	(inches)	(mm)	Quantity	Carrier
DESD18VF1BLQ-7B	X1-DFN1006-2	C/C(Reversed)	7	8	10,000	Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



C/O = Product Type Marking Code Bar Denotes Pin 1



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	Ppp	40	W	8/20µs
Peak Pulse Current	IPP	1	Α	8/20µs
ESD Protection – Contact Discharge	VESD_CONTACT	±10	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	Vesd_air	±15	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _θ JA	500	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	Vrwm	_	_	18	V	_
Reverse Current (Note 6)	I _R	_	1	30	nA	V _R = 18V
Reverse Breakdown Voltage	V _{BR}	19	22	25	V	I _R = 1mA
Reverse Clamping Voltage	V _{CL1}	_	17	_	V	I _{TLP} = 16A, t _P =100ns
Reverse Clamping Voltage	V _{CL2}	_	_	17	V	I _{PP} = 1A, t _P = 8/20µs
Dynamic Resistance	R _{DYN}	_	0.5	_	Ω	TLP, 10A, t _P = 100ns
Capacitance	Ст	-	0.3	0.45	pF	V _R = 0V, f = 1MHz

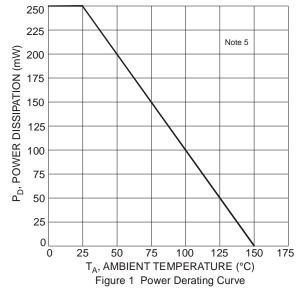
Notes:

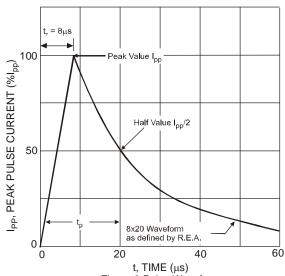
^{5.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

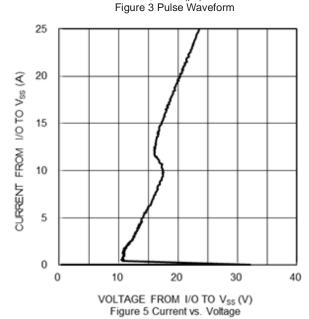
^{6.} Short duration pulse test used to minimize self-heating effect.

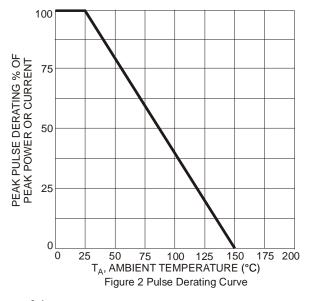


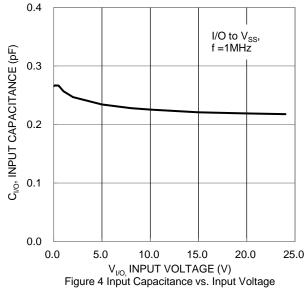










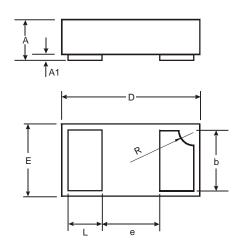




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2

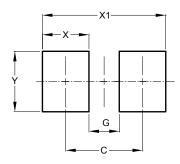


X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D		1.075			
E	0.55	0.675	0.60		
е	•	-	0.40		
Ĺ	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2



Dimensions	Value (mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Y	0.70		



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